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LY530AL

MEMS inertial sensor single-axis analog and digital output yaw rate gyroscope

Preliminary Data

Features

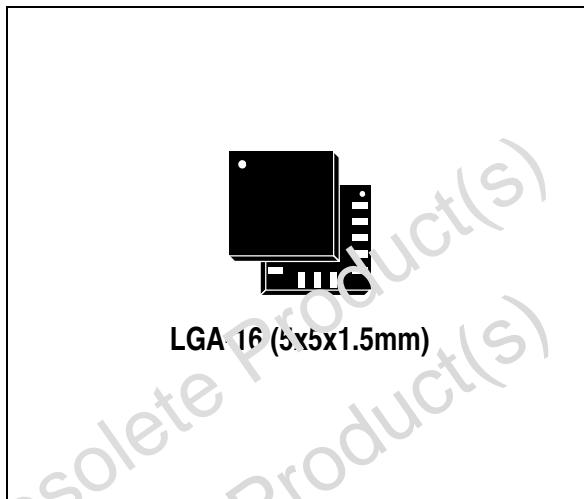
- 2.7 V to 3.6 V single supply operation
- Low power consumption
- Embedded power-down
- $\pm 300^\circ/\text{sec}$ full scale
- Absolute analog rate output
- I²C/SPI digital output interface
- Integrated low-pass filters
- Additional high pass filter for digital output
- Embedded self-test
- High shock survivability
- ECOPACK® RoHS and “Green” compliant (see [Section 7](#))

Description

The LY530AL is a low-power single axis yaw rate sensor. It includes a sensing element and an IC interface able to provide the measured angular rate to the external world through an analog output voltage and I²C/SPI digital interfaces.

The sensing element, capable of detecting the yaw rate, is manufactured using a dedicated micromachining process developed by ST to produce inertial sensors and actuators on silicon wafers.

The IC interface is manufactured using a CMOS process that allows a high level of integration to design a dedicated circuit which is trimmed to better match the sensing element characteristics.



The output of LY530AL has a full scale of $\pm 300^\circ/\text{s}$ and is capable of measuring rates with a -3 dB bandwidth up to 88 Hz.

The LY530AL is available in a plastic land grid array (LGA) package and can operate within a temperature range from -40 °C to +85 °C.

The LY530AL belongs to a family of products suitable for a variety of applications, including:

- Gaming and virtual reality input devices
- Motion control with MMI (man-machine interface)
- Image stabilization for digital video and digital still cameras
- GPS navigation systems
- Appliances and robotics

Table 1. Device summary

| Order code | Temperature range (°C) | Package | Packing |
|------------|------------------------|------------------|---------------|
| LY530AL | -40 to +85 | LGA-16 (5x5x1.5) | Tray |
| LY530ALTR | -40 to +85 | LGA-16 (5x5x1.5) | Tape and reel |

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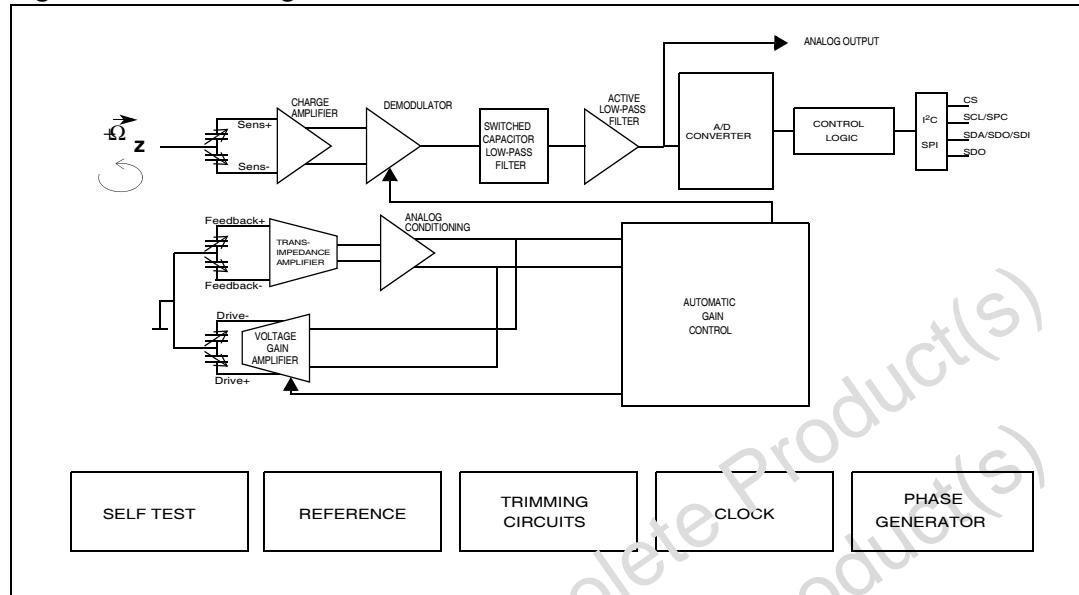
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Block diagram and pin description

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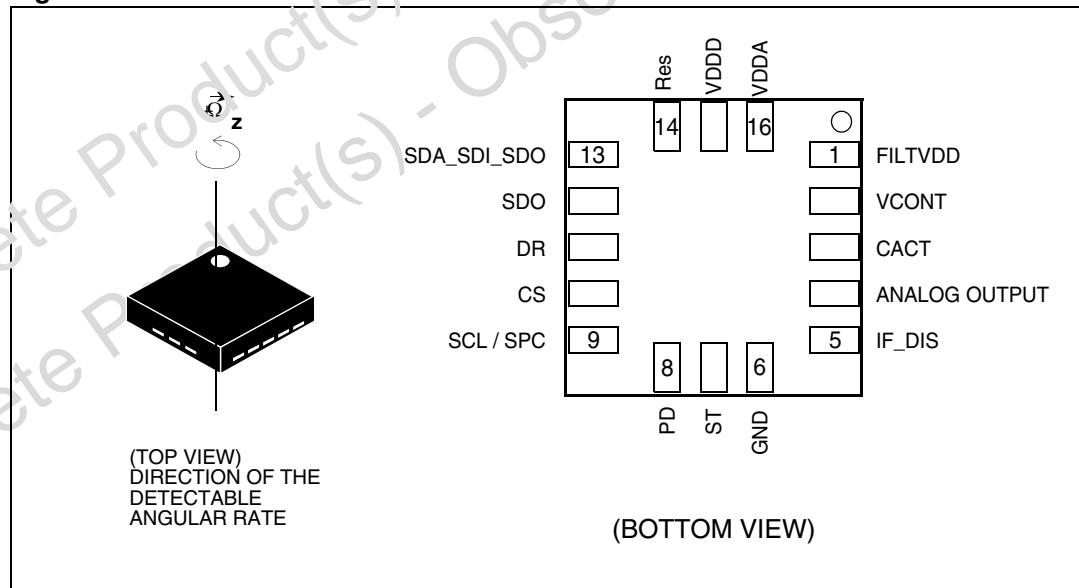
1 Block diagram and pin description

Figure 1. Block diagram



1.1 Pin description

Figure 2. Pin connection



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Block diagram and pin description

Table 2. Pin description

| Pin # | Pin Name | Analog function | Digital function |
|-------|---------------|---|--|
| 1 | FILTVDD | PLL filter connection pin #2 | PLL filter connection pin #2 |
| 2 | VCONT | PLL filter connection pin #1 | PLL filter connection pin #1 |
| 3 | CACT | Active filter capacitor | Active filter capacitor |
| 4 | ANALOG OUTPUT | Rate signal output voltage | Leave unconnected |
| 5 | IF_DIS | Leave unconnected | Digital Interface Selection (See Table 19) |
| 6 | GND | 0V supply voltage | 0V supply voltage |
| 7 | ST | Self-test (logic 0: normal mode; logic 1: self-test) | Leave unconnected |
| 8 | PD | Power-down (logic 0: normal mode; logic 1: power-down mode) | Connect to Vdd |
| 9 | SCL SPC | Leave unconnected | I ² C Serial Clock (SCL) SPI Serial Port Clock (SFC) |
| 10 | CS | Leave unconnected | SPI enable I ² C/SPI mode selection (1: I ² C mode; 0: SPI mode) |
| 11 | DR | Leave unconnected | DataReady |
| 12 | SDO | Leave unconnected or connect to Vdd | SPI Serial data output (4-wire mode only) I ² C less significant bit of the device address |
| 13 | SDA_SDI_SDO | Leave unconnected or connect to Vdd | I ² C Serial Data (SDA) SPI Serial Data Input (SDI) 3-wire Interface Serial Data Output |
| 14 | Res | Connect to Vdd | Connect to Vdd |
| 15 | VDDD | Digital side Vdd supply | Digital side Vdd supply |
| 16 | VDDA | Analog side Vdd supply | Analog side Vdd supply |

Mechanical and electrical specifications

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2 Mechanical and electrical specifications

2.1 Mechanical characteristics (analog output)

Table 3. Mechanical characteristics @ Vdd = 3.3 V, T = 25 °C unless otherwise noted⁽¹⁾

| Symbol | Parameter | Test condition | Min. | Typ. ⁽²⁾ | Max. | Unit |
|--------|--|--------------------------|------|---------------------|------|--------------------------|
| FS | Measurement range | | | ±300 | | °/s |
| So | Sensitivity | | | 3.3 | | mV/ °/s |
| SoDr | Sensitivity change vs. temperature | From -40 °C to +85 °C | | 4 | | % |
| Voff | Zero-rate level ⁽³⁾ | | | 1.65 | | V |
| OffDr | Zero-rate level change vs. temperature | From -40 °C to +85 °C | | 5 | | °/s |
| NL | Non linearity ⁽⁴⁾ | Best fit straight line | | ±0.8 | | % FS |
| BW | -3dB bandwidth ⁽⁵⁾⁽⁶⁾ | C _{ACT} = 10 nF | | 58 | | Hz |
| Rn | Rate noise density | | | 0.1 | | °/s / $\sqrt{\text{Hz}}$ |
| Vt | Self-test output voltage change ⁽⁷⁾ | | | +300 | | mV |
| Sup | Start-up time | Settling to ±5 °/s | | 300 | | ms |
| Fres | Sensing element resonant frequency | | | 4.5 | | kHz |
| Top | Operating temperature range | | -40 | | +85 | °C |
| Wh | Product weight | | | 160 | | mg |

1. The product is factory calibrated at 3.3 V. The operational power supply range is specified in [Table 5](#).

2. Typical specifications are not guaranteed

3. Zero rate level is absolute with respect to power supply

4. Specified by design

5. The product is capable of sensing angular rates extending from DC to the selected bandwidth

6. User selectable by external capacitor C_{ACT}

7. "Self-test output voltage change" is defined as V_{out}(V_{st} = logic 1) - V_{out}(V_{st} = logic 0)

2.2 Mechanical characteristics (digital output)

Table 4. Mechanical characteristics @ Vdd = 3.3 V, T = 25 °C unless otherwise noted⁽¹⁾

| Symbol | Parameter | Test condition | Min. | Typ. ⁽²⁾ | Max. | Unit |
|--------|--------------------------------|----------------|------|---------------------|------|----------|
| So | Sensitivity | | | 1.55 | | LSb/ °/s |
| Voff | Zero-rate level ⁽³⁾ | | | 0 | | LSb |
| ODR | Output data rate | | | 1 | | kHz |

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Mechanical and electrical specifications

Table 4. Mechanical characteristics @ Vdd = 3.3 V, T = 25 °C unless otherwise noted⁽¹⁾

| Symbol | Parameter | Test condition | Min. | Typ. ⁽²⁾ | Max. | Unit |
|--------|--|----------------|------|---------------------|------|------|
| Vt | Self-test output change ⁽⁴⁾ | | | 230 | | LSb |
| Fres | Sensing element resonant frequency | | | 4.5 | | kHz |
| Top | Operating temperature range | | -40 | | +85 | °C |
| Wh | Product weight | | | 160 | | mg |

1. The product is factory calibrated at 3.3 V. The operational power supply range is specified in [Table 5](#).

2. Typical specifications are not guaranteed

3. The product is capable of sensing angular rates extending from DC to the selected bandwidth

4. "Self test output change" is defined as $OUTPUT[LSb]_{(Self\text{-}test\text{ bit}\text{ on}\text{ }OUTPUT_SEL_REG=1)} - OUTPUT[LSb]_{(Self\text{-}test\text{ bit}\text{ off}\text{ or}\text{ }OUTPUT_SEL_REG=0)}$.

Mechanical and electrical specifications

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2.3 Electrical characteristics

Table 5. Electrical characteristics @ Vdd =3.3 V, T=25 °C unless otherwise noted⁽¹⁾

| Symbol | Parameter | Test condition | Min. | Typ. ⁽²⁾ | Max. | Unit |
|-------------------|--------------------------------------|-------------------------|---------|---------------------|----------------------|------|
| Vdd | Supply voltage | | 2.7 | 3.3 | 3.6 | V |
| Idd_A | Supply current (analog) | PD pin connected to GND | | 4.8 | | mA |
| Idd_D | Supply current (digital) | | | 5.5 | | mA |
| IddPdn | Supply current in power-down mode | PD pin connected to Vdd | | 1 | | µA |
| VST | Self-test input (Analog use) | Logic 0 level | 0 | | 0.2*Vdd | V |
| | | Logic 1 level | 0.8*Vdd | | Vdd | |
| VPD | Power-down input (Analog use) | Logic 0 level | 0 | | 0.2*Vdd | V |
| | | Logic 1 level | 0.8*Vdd | | Vdd | |
| C _{ACT} | Active low-pass filter capacitor | | 10 | | | nF |
| OVS | Output voltage swing ⁽³⁾ | Iout = ±100µA | 0.4 | | V _{dd} -0.4 | V |
| C _{LOAD} | Capacitive load drive ⁽³⁾ | | 0.4 | | 10 | nF |
| Top | Operating temperature range | | -40 | | +85 | °C |

1. The product is factory calibrated at 3.3 V

2. Typical specifications are not guaranteed

3. Referred to ANALOG OUTPUT pin #6

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Mechanical and electrical specifications

2.4 Communication interface characteristics

2.4.1 SPI - serial peripheral interface

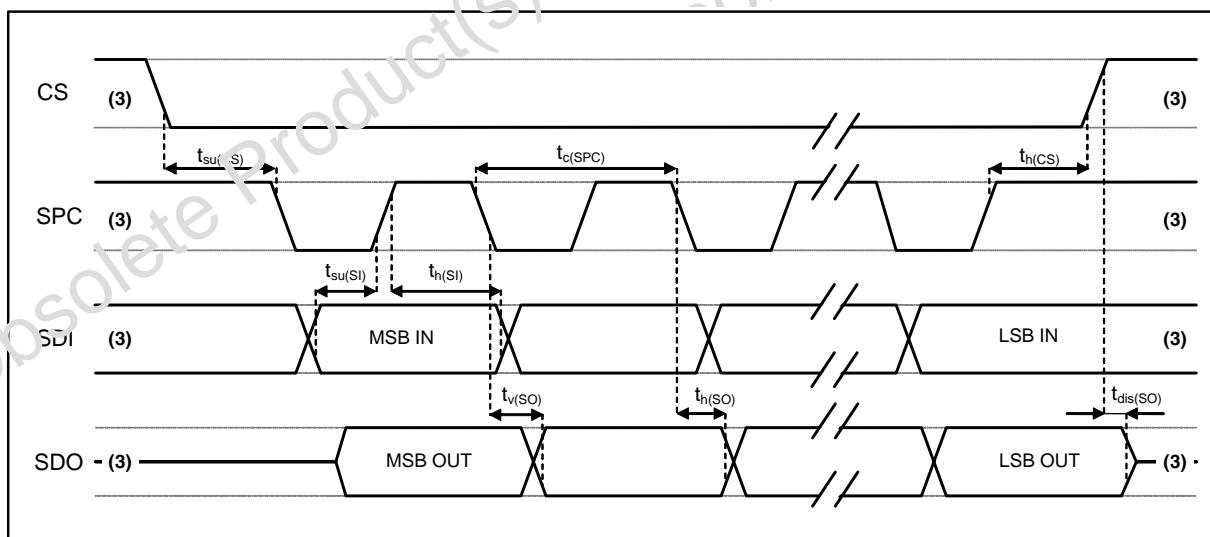
Subject to general operating conditions for Vdd and Top.

Table 6. SPI slave timing values

| Symbol | Parameter | Value ⁽¹⁾ | | Unit |
|----------|-------------------------|----------------------|-----|------|
| | | Min | Max | |
| tc(SPC) | SPI clock cycle | 100 | | ns |
| fc(SPC) | SPI clock frequency | | 10 | MHz |
| tsu(CS) | CS setup time | 5 | | |
| th(CS) | CS hold time | 8 | | |
| tsu(SI) | SDI input setup time | 5 | | |
| th(SI) | SDI input hold time | 15 | | |
| tv(SO) | SDO valid output time | | 50 | |
| th(SO) | SDO output hold time | 6 | | |
| tdis(SO) | SDO output disable time | | 50 | |

1. Values are guaranteed at 10 MHz clock frequency for SPI with both 4 and 3 wires, based on characterization results, not tested in production

Figure 3. SPI slave timing diagram⁽²⁾



2. Measurement points are done at 0.2·Vdd_IO and 0.8·Vdd_IO, for both Input and Output port
3. When no communication is on-going, data on CS, SPC, SDI and SDO are driven by internal pull-up resistors

Mechanical and electrical specifications

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2.4.2 I²C - Inter IC control interface

Subject to general operating conditions for Vdd and Top.

Table 7. I²C slave timing values

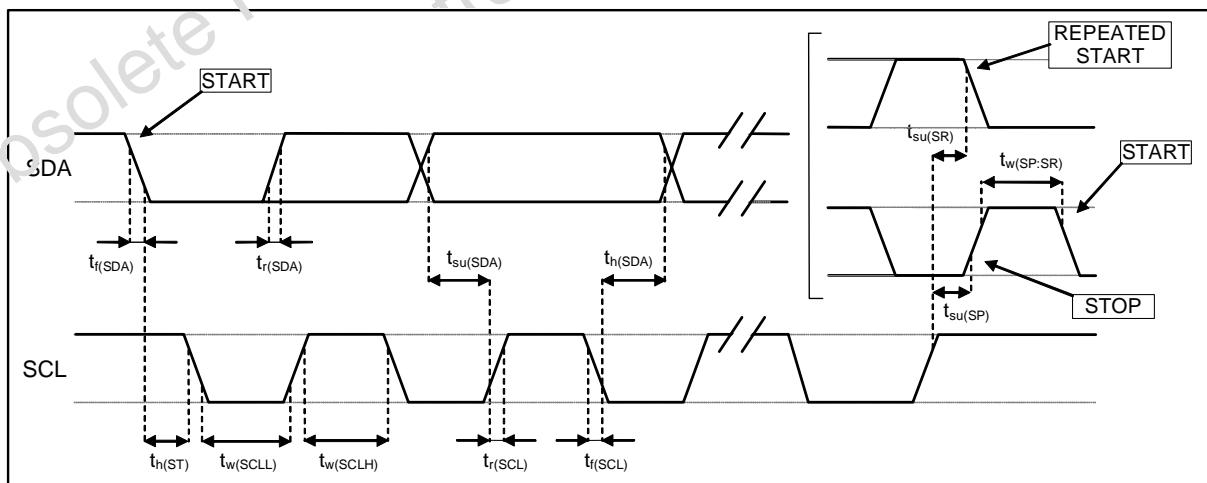
| Symbol | Parameter | I ² C Standard mode ⁽¹⁾ | | I ² C Fast mode ⁽¹⁾ | | Unit |
|-----------------------|--|---|------|---|-----|---------|
| | | Min | Max | Min | Max | |
| $f_{(SCL)}$ | SCL clock frequency | 0 | 100 | 0 | 400 | KHz |
| $t_w(SCLL)$ | SCL clock low time | 4.7 | | 1.3 | | μ s |
| $t_w(SCLH)$ | SCL clock high time | 4.0 | | 0.6 | | |
| $t_{su}(SDA)$ | SDA setup time | 250 | | 100 | | |
| $t_h(SDA)$ | SDA data hold time | 0 ⁽²⁾ | 3.45 | 0 ⁽²⁾ | 0.6 | |
| $t_r(SDA)$ $t_r(SCL)$ | SDA and SCL rise time | | 1000 | 20 + 0.1C _f ⁽³⁾ | 300 | |
| $t_f(SDA)$ $t_f(SCL)$ | SDA and SCL fall time | | 300 | 20 + 0.1C _b ⁽³⁾ | 300 | |
| $t_h(ST)$ | START condition hold time | 4 | | 0.6 | | |
| $t_{su}(SR)$ | Repeated START condition setup time | 4.7 | | 0.6 | | |
| $t_{su}(SP)$ | STOP condition setup time | | | 0.6 | | |
| $t_w(SP:SR)$ | Bus free time between STOP and START condition | 4.7 | | 1.3 | | |

1. Data based on standard I²C protocol requirement, not tested in production

2. A device must internally provide an hold time of at least 300ns for the SDA signal (referred to VIHmin of the SCL signal) to bridge the undefined region of the falling edge of SCL

3. C_b = total capacitance of one bus line, in pF

Figure 4. I²C slave timing diagram⁽⁴⁾



4. Measurement points are done at 0.2·Vdd_IO and 0.8·Vdd_IO, for both ports

LY530AL**Mechanical and electrical specifications****2.5 Absolute maximum ratings**

Stresses above those listed as "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 8. Absolute maximum ratings

| Symbol | Ratings | Maximum value | Unit |
|------------------|---|--------------------|------|
| Vdd | Supply voltage | -0.3 to 6 | V |
| Vin | Input voltage on any control pin (PD, ST) | -0.3 to Vdd +0.3 | V |
| A _{UNP} | Acceleration (not powered) | 3000 g for 0.5 ms | |
| | | 10000 g for 0.1 ms | |
| T _{STG} | Storage temperature range | -40 to +125 | °C |
| ESD | Electrostatic discharge protection | 2 (HBM) | kV |



This is a mechanical shock sensitive device, improper handling can cause permanent damage to the part



This is an ESD sensitive device, improper handling can cause permanent damage to the part

Mechanical and electrical specifications**LY530AL****2.6 Terminology****2.6.1 Sensitivity**

A yaw rate gyroscope is a Z-axis rate device that produces a positive-going output value for counterclockwise rotation around the axis normal to the package top. Sensitivity describes the gain of the sensor and can be determined by applying a defined angular velocity to it. This value changes very little over temperature and also very little over time.

2.6.2 Zero-rate level

Zero-rate level describes the actual output value if there is no angular rate present. Zero-rate level of precise MEMS sensors is, to some extent, a result of stress to the sensor and therefore zero-rate level can slightly change after mounting the sensor onto a printed circuit board or after exposing it to extensive mechanical stress. This value changes very little over temperature and also very little over time.

2.6.3 Self-test

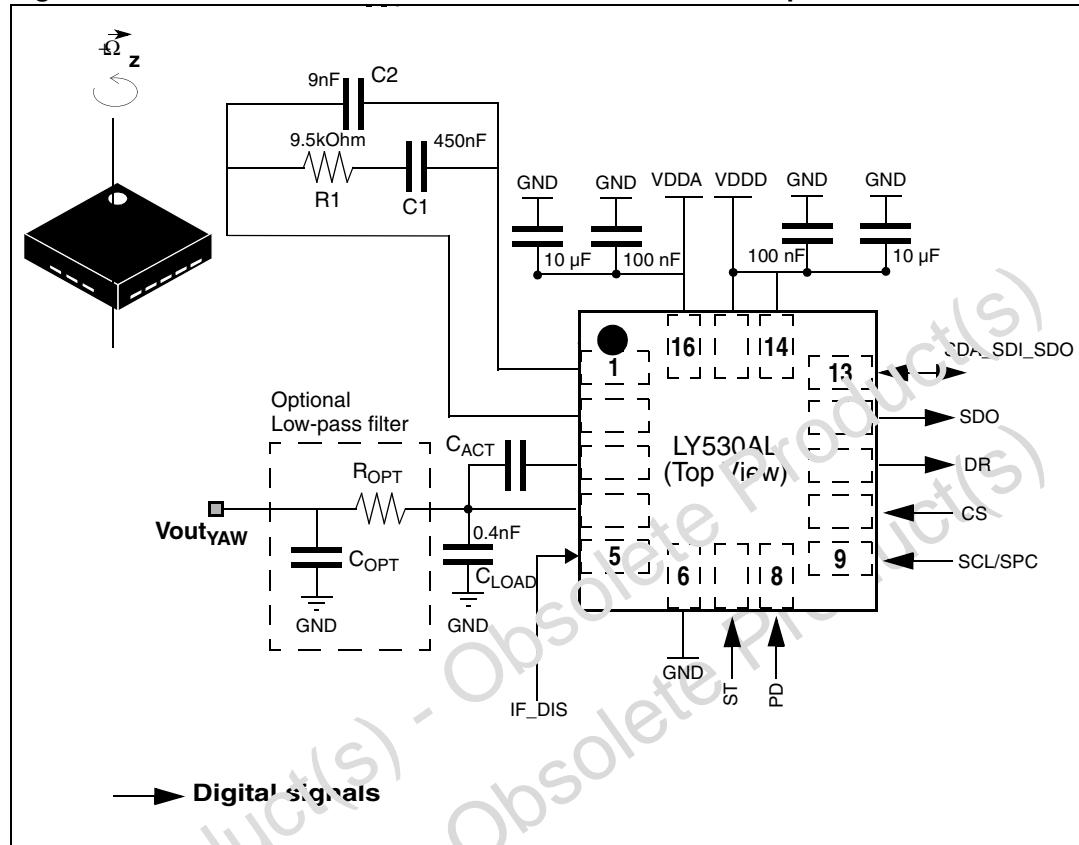
Self-test allows to test the mechanical and electric part of the sensor, allowing the seismic mass to be moved by means of an electrostatic test-force. If the device is used as analog component the Self-test function is off when the ST pin is connected to GND. When the ST pin is tied to Vdd, an actuation force is applied to the sensor, emulating a definite Coriolis force. In this case the sensor output will exhibit a voltage change in its DC level which is also depending on the supply voltage.

For the digital use of the device, the self test function is enabled acting on ST_bit inside OUTPUT_SEL_REG(23h).

When ST is active, the device output level is given by the algebraic sum of the signals produced by the velocity acting on the sensor and by the electrostatic test-force. If the output signals change within the amplitude specified in [Table 3](#), then the mechanical element is working properly and the parameters of the interface chip are within the defined specification.

3 Application hints

Figure 5. LY530AL electrical connections and external components values



Power supply decoupling capacitors (100 nF ceramic or polyester + 10 μ F Aluminum) should be placed as near as possible to the device (common design practice). VDDA(μ in 16) and VDDD(pin 15) lines have been kept separated to avoid switching noise coupling on the analog side.

The LY530AL allows to band limit the output rate response through the use of two first-order on-chip filters: a switched capacitor low-pass filter, with 400Hz -3dB bandwidth, in combination with an active low-pass filter. The active filter -3 dB nominal frequency (f_{tA}) is set through an internal resistor R_{ACT} and the external capacitor C_{ACT} (added between **CACT** pin #3 and **ANALOG OUTPUT** pin #4), by the formula:

$$f_{tA} = \frac{1}{2\pi \cdot R_{ACT} \cdot C_{ACT}}$$

The value of the internal resistor R_{ACT} is 180 k Ω , while the external capacitor C_{ACT} is used to select the signal bandwidth. The sensed frequency range spans from DC up to the selected bandwidth.

In order to further reduce high-frequency noise, the LY530AL supports an additional optional low-pass filter on **ANALOG OUTPUT** pin #4 ([Figure 5](#)). The cutoff frequency (f_{tP}) is given by the formula:

Application hints**LY530AL**

$$f_{tP} = \frac{1}{2\pi \cdot R_{OPT} \cdot C_{OPT}}$$

The LY530AL IC includes a PLL (phase locked loop) circuit to synchronize driving and sensing interfaces. Capacitors and resistors must be added at the **FILTVDD** and **VCONT** pins (as shown in *Figure 5*) to implement a second-order low-pass filter. *Table 9* summarizes the PLL low-pass filter components' values.

Table 9. PLL low-pass filter components' values

| Component | Value |
|-----------|--------------------------|
| C1 | 450 nF \pm 10% |
| C2 | 9 nF \pm 10% |
| R1 | 9.5 k Ω \pm 10% |

3.1 Soldering information

The LGA package is compliant with the ECOPACK[®], RoHS and "Green" standard. It is qualified for soldering heat resistance according to JEDEC J-STD-020C.

Leave "Pin 1 Indicator" unconnected during soldering.

Land pattern and soldering recommendations are available at www.st.com/mems.

4 Digital interfaces

The registers embedded inside the LY530AL may be accessed through both the I²C and SPI serial interfaces. The latter may be SW configured to operate either in 3-wire or 4-wire interface mode.

The serial interfaces are mapped onto the same pins. To select/exploit the I²C interface, CS line must be tied high (i.e connected to Vdd_IO).

Table 10. Serial interface pin description

| Pin name | Pin description |
|-------------|--|
| CS | SPI enable I ² C/SPI mode selection (1: I ² C mode; 0: SPI enabled) |
| SCL/SPC | I ² C Serial Clock (SCL) SPI Serial Port Clock (SPC) |
| SDA/SDI/SDO | I ² C Serial Data (SDA) SPI Serial Data Input (SDI) 3-wire Interface Serial Data Output (SDO) |
| SDO | SPI Serial Data Output (SDO) I ² C less significant bit of the device address |

4.1 I²C serial interface

The LY530AL I²C is a bus slave. The I²C is employed to write data into registers whose content can also be read back.

The relevant I²C terminology is given in the table below.

Table 11. I²C terminology

| Term | Description |
|-------------|--|
| Transmitter | The device which sends data to the bus |
| Receiver | The device which receives data from the bus |
| Master | The device which initiates a transfer, generates clock signals and terminates a transfer |
| Slave | The device addressed by the master |

There are two signals associated with the I²C bus: the Serial Clock Line (SCL) and the serial data line (SDA). The latter is a bidirectional line used for sending and receiving the data to/from the interface. Both the lines are connected to Vdd_IO through a pull-up resistor embedded inside the LY530AL. When the bus is free both the lines are high.

The I²C interface is compliant with fast mode (400 kHz) I²C standards as well as with the normal mode.

4.1.1 I²C operation

The transaction on the bus is started through a START (ST) signal. A START condition is defined as a HIGH to LOW transition on the data line while the SCL line is held HIGH. After this has been transmitted by the Master, the bus is considered busy. The next byte of data transmitted after the start condition contains the address of the slave in the first 7 bits and the eighth bit tells whether the Master is receiving data from the slave or transmitting data to the slave. When an address is sent, each device in the system compares the first seven bits after a start condition with its address. If they match, the device considers itself addressed by the Master.

The Slave ADdress (SAD) associated to the LY530AL is 110100xb. **SDO** pin can be used to modify less significant bit of the device address. If SDO pin is connected to voltage supply LSb is '1' (address 1101001b) else if SDO pin is connected to ground LSb value is '0' (address 1101000b). This solution permits to connect and address two different gyroscopes to the same I²C bus.

Data transfer with acknowledge is mandatory. The transmitter must release the SDA line during the acknowledge pulse. The receiver must then pull the data line LOW so that it remains stable low during the HIGH period of the acknowledge clock pulse. A receiver which has been addressed is obliged to generate an acknowledge after each byte of data received.

The I²C embedded inside the LY530AL behaves like a slave device and the following protocol must be adhered to. After the start condition (ST) a slave address is sent, once a slave acknowledge (SAK) has been returned, a 8-bit sub-address will be transmitted: the 7 LSb represent the actual register address while the MSB enables address auto increment. If the MSb of the SUB field is 1, the SUB (register address) will be automatically incremented to allow multiple data read/write.

The slave address is completed with a Read/Write bit. If the bit was '1' (Read), a repeated START (SR) condition will have to be issued after the two sub-address bytes; if the bit is '0' (Write) the Master will transmit to the slave with direction unchanged. *Table* explains how the SAD+Read/Write bit pattern is composed, listing all the possible configurations.

Table 12. SAD+Read/Write patterns

| Command | SAD[6:1] | SAD[0] = SDO | R/W | SAD+R/W |
|---------|----------|--------------|-----|----------------|
| Read | 110100 | 0 | 1 | 11010001 (39h) |
| Write | 110100 | 0 | 0 | 11010000 (38h) |
| Read | 110100 | 1 | 1 | 11010011 (3Bh) |
| Write | 110100 | 1 | 0 | 11010010 (3Ah) |

Table 13. Transfer when Master is writing one byte to slave

| Master | ST | SAD + W | | SUB | | DATA | | SP |
|--------|----|---------|-----|-----|-----|------|-----|----|
| Slave | | | SAK | | SAK | | SAK | |

Table 14. Transfer when Master is writing multiple bytes to slave

| | | | | | | | | | | |
|--------|----|---------|-----|-----|-----|------|-----|------|-----|----|
| Master | ST | SAD + W | | SUB | | DATA | | DATA | | SP |
| Slave | | | SAK | | SAK | | SAK | | SAK | |

Table 15. Transfer when Master is receiving (reading) one byte of data from slave

| | | | | | | | | | | | |
|--------|----|---------|-----|-----|-----|----|---------|-----|------|------|----|
| Master | ST | SAD + W | | SUB | | SR | SAD + R | | | NMAK | SP |
| Slave | | | SAK | | SAK | | | SAK | DATA | | |

Table 16. Transfer when Master is receiving (reading) multiple bytes of data from slave

| | | | | | | | | | | | | | | |
|--------|----|-------|-----|-----|-----|----|-------|-----|------|--|------|--|------|----|
| Master | ST | SAD+W | | SUB | | SR | SAD+R | | MAK | | MAK | | NMAK | SP |
| Slave | | | SAK | | SAK | | | SAK | DATA | | DATA | | DATA | |

Data are transmitted in byte format (DATA). Each data transfer contains 8 bits. The number of bytes transferred per transfer is unlimited. Data is transferred with the Most Significant bit (MSb) first. If a receiver can't receive another complete byte of data until it has performed some other function, it can hold the clock line, SCL LOW to force the transmitter into a wait state. Data transfer only continues when the receiver is ready for another byte and releases the data line. If a slave receiver doesn't acknowledge the slave address (i.e. it is not able to receive because it is performing some real time function) the data line must be left HIGH by the slave. The Master can then abort the transfer. A LOW to HIGH transition on the SDA line while the SCL line is HIGH is defined as a STOP condition. Each data transfer must be terminated by the generation of a STOP (SP) condition.

In order to read multiple bytes, it is necessary to assert the most significant bit of the sub-address field. In other words, SUB(7) must be equal to 1 while SUB(6-0) represents the address of first register to be read.

In the presented communication format MAK is Master Acknowledge and NMAK is No Master Acknowledge.

4.2 SPI bus interface

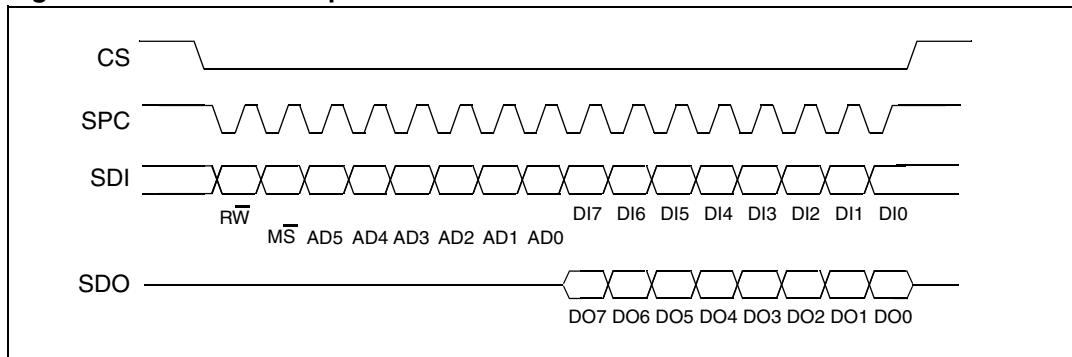
The LY530AL SPI is a bus slave. The SPI allows to write and read the registers of the device.

The Serial Interface interacts with the outside world with 4 wires: **CS**, **SPC**, **SDI** and **SDO**.

Digital interfaces

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Figure 6. Read & write protocol



CS is the Serial Port Enable and it is controlled by the SPI master. It goes low at the start of the transmission and goes back high at the end. **SPC** is the Serial Port Clock and it is controlled by the SPI master. It is stopped high when **CS** is high (no transmission). **SDI** and **SDO** are respectively the Serial Port Data Input and Output. Those lines are driven at the falling edge of **SPC** and should be captured at the rising edge of **SPC**.

Both the Read Register and Write Register commands are completed in 16 clock pulses or in multiple of 8 in case of multiple bytes read/write. Bit duration is the time between two falling edges of **SPC**. The first bit (bit 0) starts at the first falling edge of **SPC** after the falling edge of **CS** while the last bit (bit 15, bit 23, ...) starts at the last falling edge of **SPC** just before the rising edge of **CS**.

bit 0: **RW** bit. When 0, the data DI(7:0) is written into the device. When 1, the data DO(7:0) from the device is read. In latter case, the chip will drive **SDO** at the start of bit 8.

bit 1: **MS** bit. When 0, the address will remain unchanged in multiple read/write commands. When 1, the address will be auto incremented in multiple read/write commands.

bit 2-7: address AD(5:0). This is the address field of the indexed register.

bit 8-15: data DI(7:0) (write mode). This is the data that will be written into the device (MSb first).

bit 8-15: data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

In multiple read/write commands further blocks of 8 clock periods will be added. When **MS** bit is 0 the address used to read/write data remains the same for every block. When **MS** bit is 1 the address used to read/write data is incremented at every block.

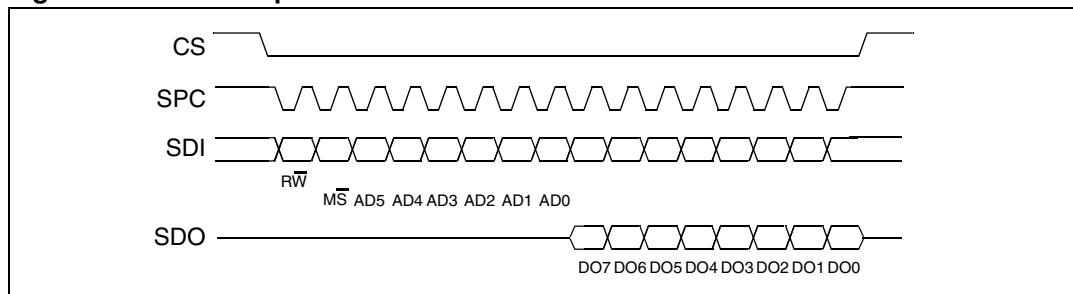
The function and the behavior of **SDI** and **SDO** remain unchanged.

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Digital interfaces

4.2.1 SPI read

Figure 7. SPI read protocol



The SPI Read command is performed with 16 clock pulses. Multiple byte read command is performed adding blocks of 8 clock pulses at the previous one.

bit 0: READ bit. The value is 1.

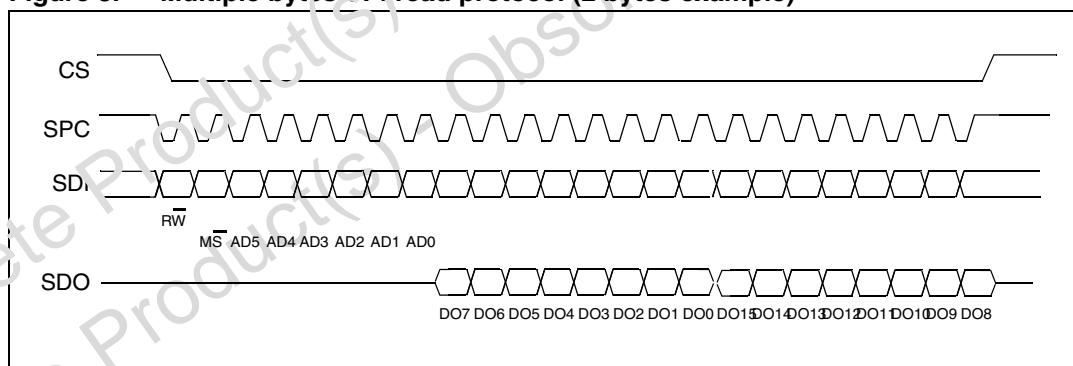
bit 1: \overline{MS} bit. When 0 do not increment address, when 1 increment address in multiple reading.

bit 2-7: address AD(5:0). This is the address field of the indexed register.

bit 8-15: data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

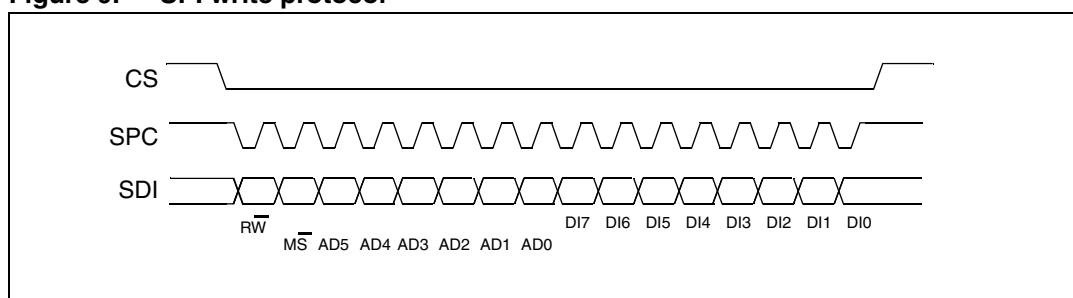
bit 16-... : data DO(...-8). Further data in multiple byte reading.

Figure 8. Multiple bytes SPI read protocol (2 bytes example)



4.2.2 SPI write

Figure 9. SPI write protocol



Digital interfaces

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The SPI Write command is performed with 16 clock pulses. Multiple byte write command is performed adding blocks of 8 clock pulses at the previous one.

bit 0: WRITE bit. The value is 0.

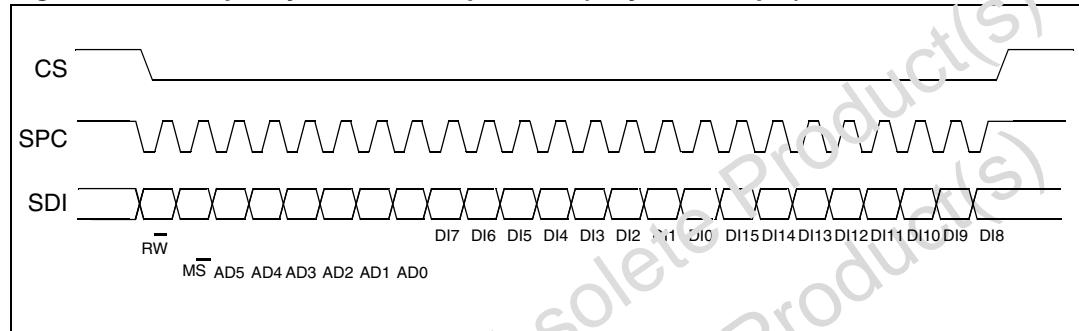
bit 1: \overline{MS} bit. When 0 do not increment address, when 1 increment address in multiple writing.

bit 2 -7: address AD(5:0). This is the address field of the indexed register.

bit 8-15: data DI(7:0) (write mode). This is the data that will be written inside the device (MSb first).

bit 16-... : data DI(...-8). Further data in multiple byte writing.

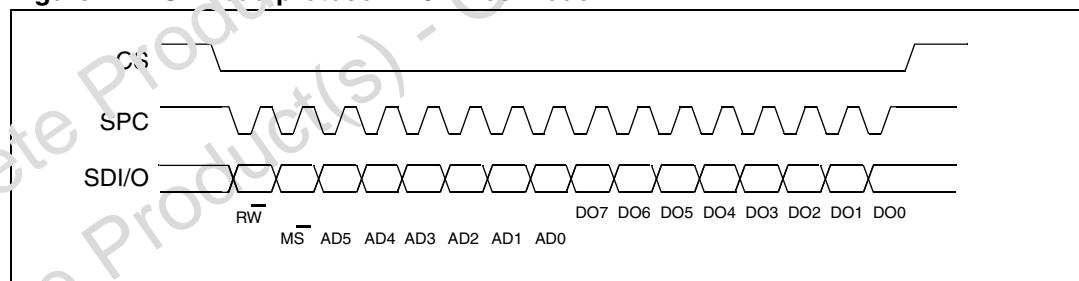
Figure 10. Multiple bytes SPI write protocol (2 bytes example)



4.2.3 SPI read in 3-wires mode

3-wires mode is entered by setting to 1 bit SIM (SPI Serial Interface Mode selection) in CTRL_REG2.

Figure 11. SPI read protocol in 3-wires mode



The SPI Read command is performed with 16 clock pulses:

bit 0: READ bit. The value is 1.

bit 1: \overline{MS} bit. When 0 do not increment address, when 1 increment address in multiple reading.

bit 2-7: address AD(5:0). This is the address field of the indexed register.

bit 8-15: data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

Multiple read command is also available in 3-wires mode.

5 Register mapping

The table given below provides a listing of the 8 bit registers embedded in the device and the related addresses:

Table 17. Registers addresses map

| Name | Type | Register address | | Default | Comment |
|--------------------------|------|------------------|----------|----------|----------------|
| | | Hex | Binary | | |
| Reserved (do not modify) | | 00-0E | | | Reserved |
| WHO_AM_I | r | 0F | 000 1111 | 11010001 | Dummy register |
| Reserved (do not modify) | | 10-1F | | | Reserved |
| CTRL_REG | rw | 20 | 010 0000 | 00000000 | |
| Reserved (do not modify) | | 21 | 010 0001 | | Reserved |
| FILTER_CFG_REG | rw | 22 | 010 0010 | | Loaded at boot |
| OUTPUT_SEL_REG | rw | 23 | 010 0011 | 00000000 | |
| Reserved (do not modify) | | 24 | 001 1000 | | Reserved |
| Reserved (do not modify) | | 25 | 001 1001 | | Reserved |
| Reserved (do not modify) | | 26 | 001 1010 | | Reserved |
| STATUS_REG | r | 27 | 010 0111 | 00000000 | |
| OUT_CONV_H | r | 28 | 010 1000 | | |
| OUT_CONV_L | r | 29 | 010 1001 | | |

Registers marked as "Reserved" or not listed must not be changed. The writing to those registers may cause permanent damages to the device.

Register description

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6 Register description

The device contains a set of registers which are used to control its behavior and to retrieve angular rate data. The registers address, made of 7 bits, is used to identify them and to write the data through serial interface.

6.1 WHO_AM_I (0Fh)

Table 18. WHO_AM_I register

| | | | | | | | |
|---|---|---|---|---|---|---|---|
| 1 | 1 | 0 | 1 | 0 | 0 | 0 | 1 |
|---|---|---|---|---|---|---|---|

Device identification register.

This register contains the device identifier that for LY530AL is set to D10.

6.2 CTRL_REG (20h)

Table 19. CTRL_REG register

| | | | | | | | |
|---------|--------|------------------|--------|-----|-----|------|-----|
| TUD_SDO | DIG_en | 0 ⁽¹⁾ | IF_SEL | SDU | alg | BOOT | SIM |
|---------|--------|------------------|--------|-----|-----|------|-----|

1. '0' is the default value. This value must not be changed

Table 20. CTRL_REG description

| | |
|---------|--|
| TUD_SDO | Pull Up disable for SDO pin. Default value: 0 (0: Pull Up connected; 1: Pull Up disabled) |
| DIG_en | Power Down bit. Default value: 0 (0: Device is in power down mode; 1: Device is in normal mode) |
| IF_SEL | Interface selection. Default value: 0 (0: both interfaces available; 1: IF_DIS pin value selects the interface) |
| BDU | Block data update. Default value: 0 (0: continuos update; 1: update inhibited) |
| alg | Data alignment selection bit. Default value: 0 (0: 16 bit left justified; 1: 10 bit right justified) |
| BOOT | Reboot of memory content. Default value: 0 (0: normal mode; 1: memory reboot) |
| SIM | SPI serial interface mode selection bit. Default value: 0 (0: 4-wire mode; 1:3-wire mode) |

TUD_SDO: When this bit is set to '1' the Pull Up on SDO pin is disabled.

DIG_en: When this bit is set to '1' the device is in normal mode. When DIG_en bit is '0' the device is in power down mode.

IF_SEL: Setting this bit to '1' the voltage value applied to IF_DIS pin selects one of the two digital interfaces ('1' for I2C only, '0' for SPI only).

LY530AL

Register description

BDU: This bit is used to inhibit output registers update until both upper and lower parts are read. In default mode (BDU='0') the output registers values are updated continuously. It is recommended to set BDU bit to '1' if the reading is not faster than the output data rate.

alg: This bit permits to decide between 16 bits left justified (default value) and 10 bits right justified representation of data coming from the device. In this last case the most significant bits are replaced by the bit representing the sign.

BOOT bit is used to refresh the content of internal registers stored in the flash memory block. At the device power up the content of the flash memory block is transferred to the internal registers related to trimming functions to permit a good behavior of the device itself. If for any reason the content of trimming registers was changed it is sufficient to use this bit to restore correct values. When BOOT bit is set to '1' the content of internal flash is copied inside corresponding internal registers and it is used to calibrate the device. These values are factory trimmed and they are different for every gyroscope. They permit a good behavior of the device and normally they have not to be changed. At the end of the boot process the BOOT bit is set again to '0'.

SIM bit selects the SPI Serial Interface Mode. When SIM is '0' (default value) the 4-wire interface mode is selected. The data coming from the device are sent to SDO pin. In 3-wire interface mode output data are sent to SDA/SDI/SDO pin.

6.3 FILTER_CFG_REG (22h)

Table 21. FILTER_CFG_REG register

| | | | | | | | |
|--------|--------|--------|--------|--------|------------------|---|---|
| HP_BW1 | HP_BW0 | LP_BW2 | LP_BW1 | LP_BW0 | 0 ⁽¹⁾ | 0 | 0 |
|--------|--------|--------|--------|--------|------------------|---|---|

1. 0 is the default value loaded at boot. This value must not be changed.

Table 22. FILTER_CFG_REG description

| | |
|------------|---|
| HP_BW(1:0) | High pass filter pole frequency selection |
| LP_BW(2:0) | Low pass filter pole frequency selection |

Table 23. High pass filter pole -3dB frequency selection

| HP_BW[1:0] | Pole frequency [Hz] |
|------------|---------------------|
| 00 | 1.25 |
| 01 | 0.31 |
| 10 | 0.15 |
| 11 | 0.08 |

Table 24. Low pass filter pole -3dB frequency selection

| LP_BW[2:0] | Pole frequency [Hz] |
|------------|---------------------|
| 000 | 115 |
| 001 | 46.1 |
| 010 | 21.3 |

Register description

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Table 24. Low pass filter pole -3dB frequency selection (continued)

| LP_BW[2:0] | Pole frequency [Hz] |
|------------|---------------------|
| 011 | 10.3 |
| 100 | 5.1 |
| 101 | 2.5 |
| 110 | 1.2 |
| 111 | 0.6 |

6.4 OUTPUT_SEL_REG (23h)

Table 25. OUTPUT_SEL_REG register

| | | | | | | | |
|---|---|--------|---|---|------|------|------|
| X | X | ST_bit | X | X | OUT2 | OUT1 | OUT0 |
|---|---|--------|---|---|------|------|------|

Table 26. OUTPUT_SEL_REG description

| | |
|--------|---|
| ST_bit | When Dig_en is set to '1', ST_bit enables Self test function. Default value: 0 (0: no self test activated; 1: self test enabled) |
| OUT2-0 | Output data filtering selection |

Table 27. Filtering selection

| OUTPUT_SEL_REG[2:0] | Filter type |
|---------------------|--------------------------|
| 000 | no filtering |
| 001 | high pass |
| 011 | 2 x high pass |
| 100 | low pass |
| 101 | high pass + low pass |
| 111 | 2 x high pass + low pass |

Table 28. Forbidden combinations

| FILTER_CFG_REG[2:0] | OUTPUT_SEL_REG[2:0] |
|---------------------|---------------------|
| 101 | 111 |
| 101 | 100 |
| 100 | 111 |
| 100 | 101 |
| 111 | 101 |
| 111 | 100 |

LY530AL

Register description

6.5 STATUS_REG(27h)

Table 29. STATUS_REG(27h) register

| | | | | | | | |
|------------------|---|---|---|---|----|-------|-------|
| X ⁽¹⁾ | X | X | X | X | ow | davbH | davbL |
|------------------|---|---|---|---|----|-------|-------|

1. Undefined value

Table 30. STATUS_REG(27h) description

| | |
|-------|---|
| ow | Digital data overrun. When '1', output registers have been updated before being read. |
| davbH | When this bit is '1', new data is available on OUT_CONV_H (high part) |
| davbL | When this bit is '1', new data is available on OUT_CONV_L (low part) |

6.6 OUT_CONV_H(28h)

Table 31. OUT_CONV_H register

| | | | | | | | |
|------|------|------|------|------|------|------|------|
| DOH7 | DOH6 | DOH5 | DOH4 | DOH3 | DOH2 | DOH1 | DOH0 |
|------|------|------|------|------|------|------|------|

These bits are the high part of digital output expressed as 2's complement number. For data alignment see alg bit in CTRL_REG(20h) ([Table 20](#)).

6.7 OUT_CONV_L(29h)

Table 32. OUT_CONV_L register

| | | | | | | | |
|------|------|------|------|------|------|------|------|
| DOL7 | DOL6 | DOL5 | DOL4 | DOL3 | DOL2 | DOL1 | DOL0 |
|------|------|------|------|------|------|------|------|

These bits are the lowpart of digital output expressed as 2's complement number. For data alignment see alg bit in CTRL_REG(20h) ([Table 20](#)).

Package information

LY530AL

7 Package information

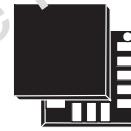
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK® is an ST trademark.

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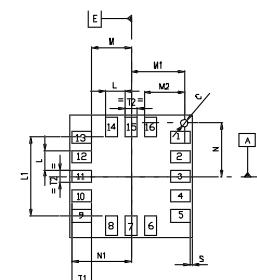
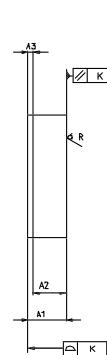
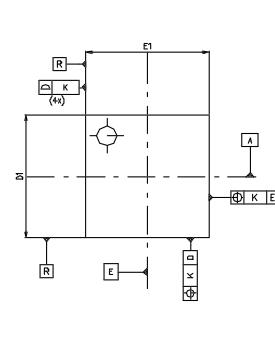
Figure 12. LGA-16: mechanical data and package dimensions

| Ref. | Dimensions | | | inch | | | |
|------|------------|-------|-------|-------|-------|-------|-------|
| | mm | | Max. | Min. | | Typ. | Max. |
| | Min. | Typ. | | Min. | Typ. | | |
| A1 | 1.46 | 1.5 | 1.6 | 0.057 | 0.059 | 0.063 | |
| A2 | | | 1.33 | | | | 0.052 |
| A3 | 0.16 | 0.2 | 0.24 | 0.006 | 0.008 | 0.009 | |
| C | | 0.3 | | | 0.012 | | |
| D1 | 4.85 | 5 | 5.15 | 0.191 | 0.197 | 0.203 | |
| E1 | 4.85 | 5 | 5.15 | 0.191 | 0.197 | 0.203 | |
| L | | 0.8 | | | 0.031 | | |
| L1 | | 3.2 | | | 0.126 | | |
| M | | 1.6 | | | 0.062 | | |
| M1 | 2.15 | 2.175 | 2.20 | 0.085 | 0.086 | 0.087 | |
| M2 | | 1.625 | | | 0.064 | | |
| N | | 2.175 | | | 0.086 | | |
| N1 | | 2.4 | | | 0.094 | | |
| T1 | | 0.8 | | | 0.031 | | |
| T2 | 0.475 | 0.5 | 0.525 | 0.019 | 0.020 | 0.021 | |
| R | 1.2 | | 1.6 | 0.047 | | 0.063 | |
| S | | 0.1 | | | 0.004 | | |
| h | | 0.15 | | | 0.006 | | |
| k | | 0.05 | | | 0.002 | | |
| j | | 0.1 | | | 0.004 | | |

Outline and mechanical data



**LGA-16 (5x5x1.6mm)
Land Grid Array Package**



7887555A

8 Revision history**Table 33. Document revision history**

| Date | Revision | Changes |
|-------------|----------|-----------------|
| 03-Sep-2008 | 1 | Initial release |

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